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TS00-563



2823
January 25, 2004

TO: Commissioner of Patents
P.O. Box 1450
Alexandria VA 22313-1450

FROM: Stephen Ackerman Reg. No. 37,761
28 Davis Avenue
Poughkeepsie, N.Y. 12603

SUBJECT: Serial # 09/863,224 File Date: 05/24/2001
Inventor: Ming-Hsing Tsai
Examiner: Neal Berezny
Art Unit: 2823
Title: A Method To Solve Via Poisoning For Porous Low-K Dielectric

RESPONSE TO OFFICE ACTION

This is in response to the Final Office Action dated 01/12/2004. Please amend the above identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to :
Commissioner of Patents P.O. Box 1450 Alexandria VA 22313-1450 on

April 12, 2004.

Signature  Date: _____
Stephen B. Ackerman, Reg. No. 37,761

4/12, 2004



TSMC-563

Application No. : 09/863,224
Inventor : Ming-Hsing Tsai
File Date : 05/24/2001
Art Unit : 2823
Examiner : Neal Berezny

Confirmation No. _____

Docket No. : TSMC 00-085
Customer No. : _____

Commissioner of Patents
P.O. Box 1450
Alexandria VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action of 01/12/2004, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of the paper.

Remarks/Arguments begin on page 11 of this paper.